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**Silicon Image**

PanelLink[®]
Technology

Sil 164
PanelLink Transmitter
Data Sheet

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Application Information

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Revision History

Revision	Date	Comment
SI-DS-0021-A	01/99	Full Release
SI-DS-0021-B	03/99	Internal Revision B release
SI-DS-0021-C	04/02	New format. I ² C programming and strapping mode description, TFT mapping and Design Recommendations, pin names ISEL/RST changed to ISEL/RST# and PD to PD#.
SI-DS-0021-D	09/02	Included Pb-free package. Added De-skew range. Corrected PD# pin number.
SI-DS-0021-E	06/05	Corrected D1 dimension. Corrected JEDEC code. Included VCC details for power measurement. Added Register Reset values and additional sample programming code.

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TABLE OF CONTENTS

General Description	1
Features	1
SiI 164 Pin Diagram	1
Functional Description	2
PanelLink TMDS Digital Core	2
I ² C Interface and Registers	2
Data Capture Logic	3
Electrical Specifications	4
Absolute Maximum Conditions	4
Normal Operating Conditions	4
Digital I/O Specifications	4
DC Specifications	5
AC Specifications	6
Input Timing Diagrams	7
Pin Descriptions	9
Input Pins	9
Configuration Pins	10
Input Voltage Reference Pin	11
Power Management Pins	11
Differential Signal Data Pins	11
Reserved Pins	11
Power and Ground Pins	11
I ² C Registers	12
I ² C Register Mapping	12
I ² C Register Definitions	13
I ² C Slave Interface and Address	15
Data De-skew Feature	16
Data Latching Modes	17
I ² C Programming Sequence	18
Enabling Hot Plug Detection Mode	18
Non-I ² C/Strap Mode Configuration	19
TFT Panel Data Mapping	21
Design Recommendations	24
1.5V to 3.3V I ² C Bus Level-Shifting	24
Voltage Ripple Regulation	25
Decoupling Capacitors	26
Series Damping Resistors on Outputs	27
Differential Trace Routing	27
Package Dimensions and Marking Specification	29
Ordering Information	29

LIST OF TABLES

Table 1. Data De-Skew Estimated Values	16
Table 2. Sample Programming Sequence for SiI 164 in 12-bit Mode	18
Table 3. Non-I ² C/Strap Mode Options	20
Table 4. One Pixel/Clock Input/Output TFT Mode - VESA P&D and FPDI-2 Compliant.....	21
Table 5. 24-bit One Pixel/Clock Input with 24-bit Two Pixels/Clock Output TFT Mode	22
Table 6. 18-bit One Pixel/Clock Input with 18-bit Two Pixels/Clock Output TFT Mode	23
Table 7. Recommended Components for Bypass and Decoupling Circuits.....	26

LIST OF FIGURES

Figure 1. Pin Diagram for SiI 164	1
Figure 2. Functional Block Diagram	2
Figure 3. Clock Cycle High/Low Times.....	7
Figure 4. Low Swing Differential Times	7
Figure 5. ISEL/RST# Minimum Timing	7
Figure 6. Input Data Setup/Hold Time to IDCK	8
Figure 7. VSYNC, HSYNC and CTL[3:1] Delay Time from DE	8
Figure 8. DE High and Low Times.....	8
Figure 9. I ² C Data Valid Delay (driving Read Cycle data).....	8
Figure 10. I ² C Byte Read.....	15
Figure 11. I ² C Byte Write	15
Figure 12. SiI 164 Data De-skew Feature Timing	16
Figure 13. 12-bit Input Data Latching	17
Figure 14. 24-bit Input Data Latching	17
Figure 15. Non- I ² C/Strap Mode Schematic Example	19
Figure 16. I ² C Bus Voltage Level-Shifting using Fairchild NDC7002N	24
Figure 17. I ² C Bus Voltage Level Shifting using Philips GTL 2010	24
Figure 18. Voltage Regulation using TL431	25
Figure 19. Voltage Regulation using LM317	25
Figure 20. Decoupling and Bypass Capacitor Placement.....	26
Figure 21. Decoupling and Bypass Schematic.....	26
Figure 22. Series Input Damping Resistors for Driving Source	27
Figure 23. Example of Incorrect Differential Signal Routing	27
Figure 24. Example of Correct Differential Signal Routing.....	28
Figure 25. Differential Trace Routing to DVI Connector(Top Side View)	28
Figure 26. 64-pin TQFP Package Dimensions (JEDEC code MS-026ACD)	29

General Description

The Sil 164 transmitter uses PanelLink® Digital technology to support displays ranging from VGA to UXGA resolutions (25 - 165Mpps) in a single link interface.

The Sil 164 transmitter has a highly flexible interface with either a 12-bit mode (½ pixel per clock edge) or 24-bit mode 1 pixel per clock edge input for true color (16.7 million) support. In 24-bit mode, the Sil 164 supports single or dual edge clocking. In 12-bit mode, the Sil164 supports dual edge single clocking or single edge dual clocking. The Sil 164 can be programmed though an I²C interface. In addition the Sil 164 also supports Receiver and Hot Plug Detection.

PanelLink Digital technology simplifies PC design by resolving many of the system level issues associated with high-speed mixed signal design, providing the system designer with a digital interface solution that is quicker to market and lower in cost.

Features

- Scaleable Bandwidth: 25 - 165MHz Flexible
- Graphics Controller Interface: 12-bit or 24-bit mode 1 pixel/clock inputs
- Flexible Input Clocking: Single clock single edge (24-bit), Single clock dual edge (12-/24-bit), Dual clock single edge (12-bit)
- I²C Slave Programming Interface up to 100kHz
- Low Voltage Interface: 3.3V with option for 1.0 to 3.0V Low Voltage Signal Mode
- Monitor Detection supported through hot plug and receiver detection
- De-skewing Option varies input clock to input data timing
- Low Power: 3.3V operation (120mA max.) and Power Down mode (1mA max.)
- Cable Distance Support: over 5m with twisted pair and fiber-optics ready
- Compliant with DVI 1.0 (DVI is backwards compliant with VESA® P&D™ and DFP)
- Standard and Pb-free packages (see pg 29)

Sil 164 Pin Diagram

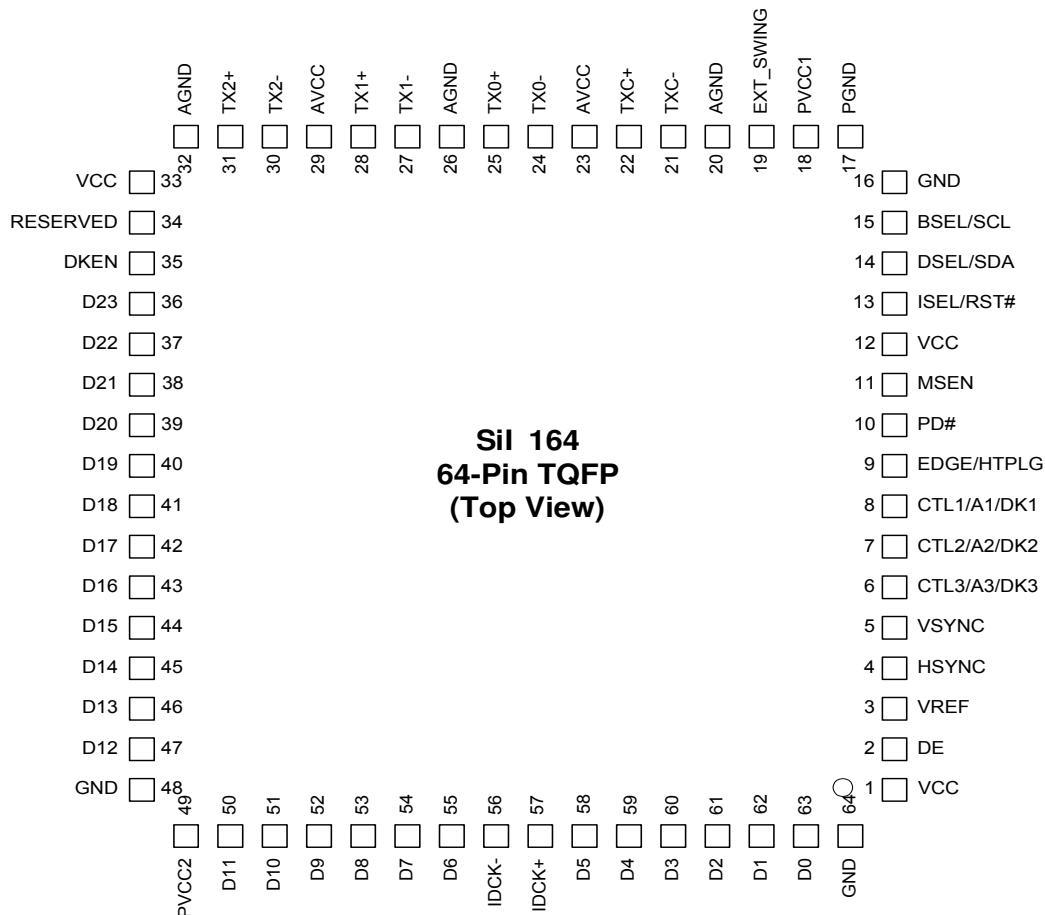


Figure 1. Pin Diagram for Sil 164

Functional Description

The SiI 164 is a DVI 1.0 compliant PanelLink transmitter in a compact package. It provides 24-bit data Input to allow for panel support up to UXGA resolution. Figure 2 shows the functional blocks of the chip.

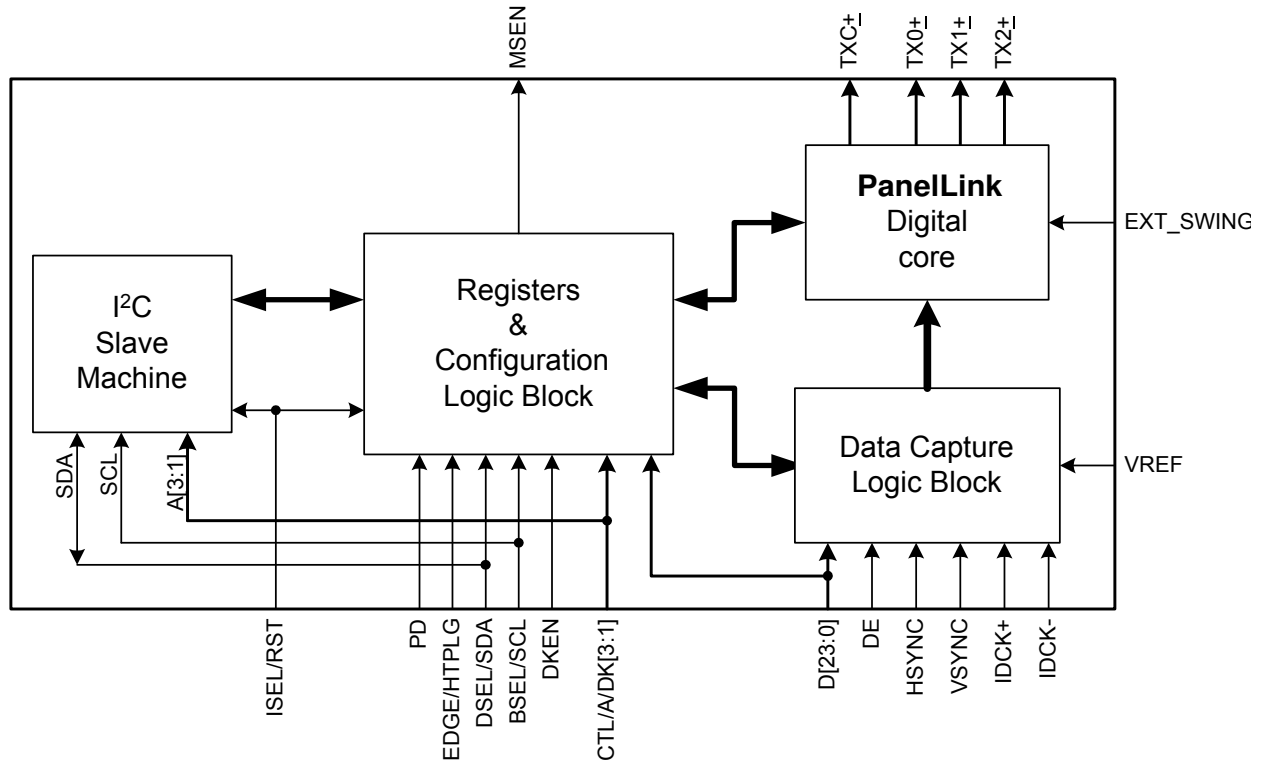


Figure 2. Functional Block Diagram

PanelLink TMDS Digital Core

The PanelLink TMDS core encodes video information onto three TMDS differential data lines and the differential clock. The video data is input by the Data Capture Logic Block, as a 12- or 24-bit bus, using one or two clocks with one or two edges per clock. An attached monitor may be sensed using the HTPLG pin or internally with Receiver Sense. This detected state may be output onto the MSEN pin. The device may be powered down using the PD# pin or with an internal register. The SiI 164 is reset using the ISEL/RST# pin. A resistor tied to the EXT_SWING pin is used to control the TMDS swing amplitude.

I²C Interface and Registers

The SiI 164 uses a slave I²C interface, capable of running at 100kHz. The slave I²C interface is not 5V tolerant. If the switching levels from the host are not 3.3V, then a voltage level shifter must be used. See Figure 16 and Figure 17 on page 24 for a system diagram.

A connected display may be detected using the DVI Hot Plug signal, attached to the HTPLG pin; or with the Receiver Sense logic internal to the SiI 164. The state of the detection, or an interrupt signal indicating a change of state, may be sent to the MSEN pin. This is useful to the host controller monitoring the SiI 164.

Data Capture Logic

Video data is input to the SI 164 by way of a 12-bit or 24-bit interface. The functionality of this interface is affected by several of the configuration register settings, as follows.

- BSEL selects between 12-bit and 24-bit input bus widths.
- DSEL selects between single-edge and dual-edge modes for the input clocks.
- EDGE selects between rising and falling edge on the input clocks.
- CLK+ and CLK- provide the one or two clocks required for latching the input data bus.
- The PD# input selects the chip power down mode and allows for disabling of the TMDS outputs.

The ISEL/RST# input resets the HDCP engine and internal registers and is asserted after power up and receipt of a stable input pixel clock.

Electrical Specifications

Absolute Maximum Conditions

Absolute Maximum Conditions are defined as the worst-case conditions the part will tolerate without sustaining damage. Permanent device damage may occur if absolute maximum conditions are exceeded. Proper operation under these conditions is not guaranteed. Functional operation should be restricted to the conditions described under Normal Operating Conditions.

Symbol	Parameter	Min	Typ	Max	Units
V_{CC}	Supply Voltage 3.3V	-0.3		4.0	V
V_I	Input Voltage	-0.3		$V_{CC} + 0.3$	V
V_O	Output Voltage	-0.3		$V_{CC} + 0.3$	V
T_J	Junction Temperature (with power applied)			125	°C
T_{STG}	Storage Temperature	-65		150	°C

Normal Operating Conditions

Symbol	Parameter	Min	Typ	Max	Units
V_{CC}	Supply Voltage	3.0	3.3	3.6	V
V_{CCN}	Supply Voltage Noise			100	mV _{P-P}
T_A	Ambient Temperature (with power applied)	0	25	70	°C
θ_{JA}	Thermal Resistance (Junction to Ambient) ¹			64	°C/W
θ_{JC}	Thermal Resistance (Junction to Case) ¹			20	°C/W

Note

1. Airflow at 0m/s.

Digital I/O Specifications

Under normal operating conditions unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V_{IH}	High Swing High-level Input Voltage	$V_{REF} = V_{CC}$	2.0			V
V_{IL}	High Swing Low-level Input Voltage	$V_{REF} = V_{CC}$			0.8	V
V_{DDQ}^2	Low Swing Voltage		1		3.0	V
V_{SH}	Low Swing High-level Input Voltage	$V_{REF} = V_{DDQ}/2$	$V_{DDQ}/2 + 300mV$			V
V_{SL}	Low Swing Low-level Input Voltage	$V_{REF} = V_{DDQ}/2$			$V_{DDQ}/2 - 100mV$	V
V_{CINL}	Input Clamp Voltage ¹	$I_{CL} = -18mA$			GND - 0.8	V
V_{CIPL}	Input Clamp Voltage ¹	$I_{CL} = 18mA$			VCC + 0.8	V
I_{IL}	Input Leakage Current		-10		10	μA
V_{IH}	High Swing High-level Input Voltage	$V_{REF} = V_{CC}$	2.0			V

Notes

1. Guaranteed by design. Voltage undershoot or overshoot cannot exceed absolute maximum conditions
2. VDDQ defines the maximum voltage level of Low Swing input. It is not an actual input voltage. Chip characterization for Low Swing operation is performed at 1.5V only. Voltage level of Low Swing input should never exceed absolute maximum rating.

DC Specifications

Under normal operating conditions unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V_{OD}	Differential Voltage Single ended peak to peak amplitude	$R_{LOAD} = 50\Omega$, $R_{EXT_SWING} = 510\Omega$	510	550	590	mV
V_{DOH}	Differential High-level Output Voltage ¹			AVCC		V
I_{DOS}	Differential Output Short Circuit Current ¹	$V_{OUT} = 0\text{ V}$			5	μA
$I_{PD\#}$	Power-down Current ²			0.2	1.0	mA
I_{CCT}	Transmitter Supply Current	IDCK= 165 MHz, 1-pixel/clock mode, $R_{EXT_SWING} = 510\Omega$, Worst Case Pattern ³		85 ⁴	120 ⁵	mA

Notes

1. Guaranteed by design.
2. Assumes all inputs to the transmitter are not toggling.
3. Black and white checkerboard pattern, each checker is one pixel wide.
4. Measurement taken at VCC = 3.30V.
5. Measurement taken at VCC = 3.60V.

AC Specifications

Under normal operating conditions unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Units	Figure
T _{CIP}	IDCK Period, 1-pixel/clock		6		40	ns	Figure 3
F _{CIP}	IDCK Frequency, 1-pixel/clock		25		165	MHz	
T _{CIH}	IDCK High Time at 165MHz		2.0			ns	Figure 3
T _{CIL}	IDCK Low Time at 165MHz		2.0			ns	Figure 3
T _{IJIT}	Worst Case IDCK Clock Jitter ^{2,3}				2	ns	
T _{SIDF}	Data, DE, VSYNC, HSYNC Setup Time to IDCK falling edge (Default De-skew Setting)	Single Edge (DSEL = 0, EDGE = 0)	1.0			ns	Figure 6
T _{HIDF}	Data, DE, VSYNC, HSYNC Hold Time from IDCK falling edge (Default De-skew Setting)	Single Edge (DSEL = 0, EDGE = 0)	0.9			ns	Figure 6
T _{SIDR}	Data, DE, VSYNC, HSYNC Setup Time to IDCK rising edge ¹ (Default De-skew Setting)	Single Edge (DSEL = 0, EDGE = 1)	1.0			ns	Figure 6
T _{HIDR}	Data, DE, VSYNC, HSYNC Hold Time from IDCK rising edge ¹ (Default De-skew Setting)	Single Edge (DSEL = 0, EDGE = 1)	0.9			ns	Figure 6
T _{SID}	Data, DE, VSYNC, HSYNC Setup Time to IDCK falling/rising edge ¹ (Default De-skew Setting)	Dual Edge (DSEL = 1, BSEL = 0)	0.6			ns	
T _{HID}	Data, DE, VSYNC, HSYNC Hold Time from IDCK falling/rising edge ¹ (Default De-skew Setting)	Dual Edge (DSEL = 1, BSEL = 0)	1.3			ns	
T _{DDF}	VSYNC, HSYNC Delay from DE falling edge ¹		1T _{CIP}			ns	Figure 7
T _{DDR}	VSYNC, HSYNC Delay to DE rising edge ¹		1T _{CIP}			ns	Figure 7
T _{HDE}	DE high time ¹				8191T _{CIP}	ns	Figure 8
T _{LDE}	DE low time ¹		128T _{CIP}			ns	Figure 8
T _{STEP}	De-skew step size increment	DKEN = 0b1		260		ps	
T _{RESET}	Duration of RESET signal Low required for valid Reset		10			μs	Figure 5
T _{I2CDVD}	SDA Data Valid Delay from SCL high to low transition ³	C _L = 10pf			700	ns	Figure 9
		C _L = 400pf			2000	ns	
S _{HLT}	Differential Swing High-to-Low Transition Time	R _{LOAD} = 50Ω, R _{EXT_SWING} = 510Ω	170	200	230	ps	Figure 4
S _{LHT}	Differential Swing Low-to-High Transition Time	R _{LOAD} = 50Ω, R _{EXT_SWING} = 510Ω	170	200	230	ps	Figure 4

Notes

1. Guaranteed by design.
2. Actual jitter tolerance may be higher depending on the frequency of the jitter.
3. All Standard mode I²C (100kHz) timing requirements are guaranteed by design. Fast mode I²C (400kHz) timing requirements are guaranteed at 10pf loading.

Input Timing Diagrams

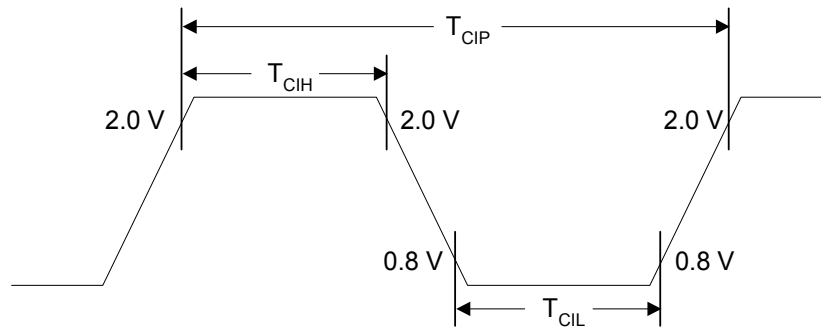


Figure 3. Clock Cycle High/Low Times

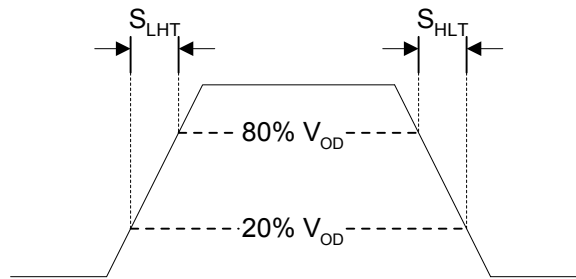


Figure 4. Low Swing Differential Times

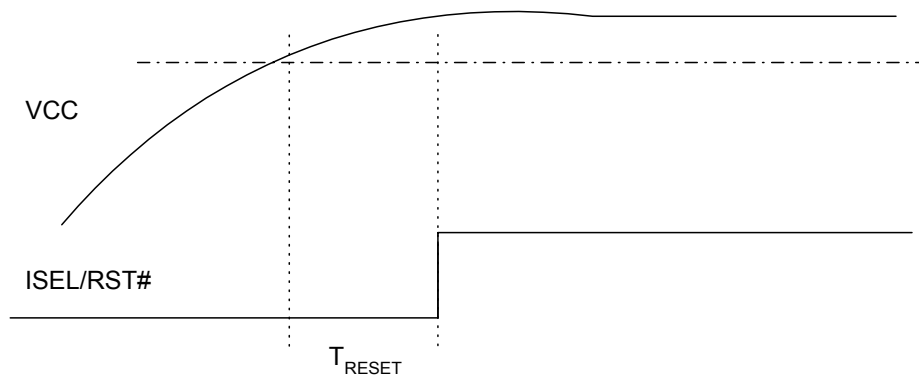


Figure 5. ISEL/RST# Minimum Timing

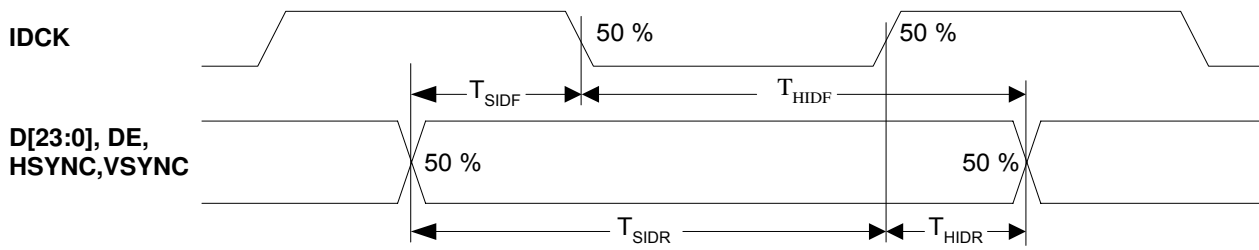


Figure 6. Input Data Setup/Hold Time to IDCK

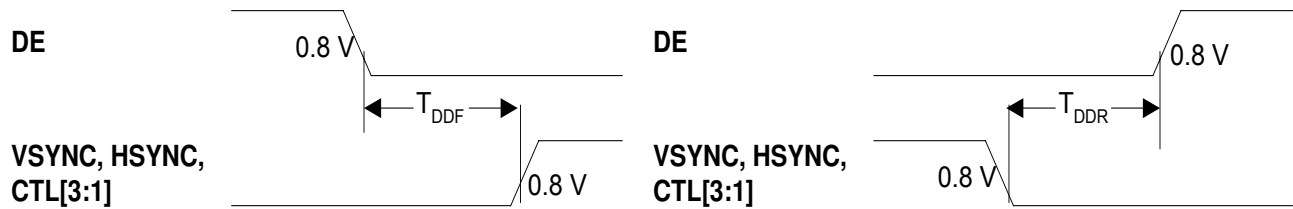


Figure 7. VSYNC, HSYNC and CTL[3:1] Delay Time from DE

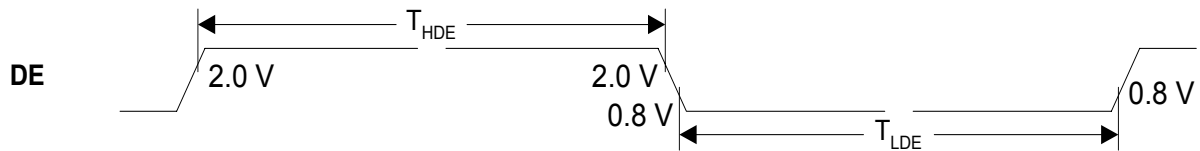


Figure 8. DE High and Low Times

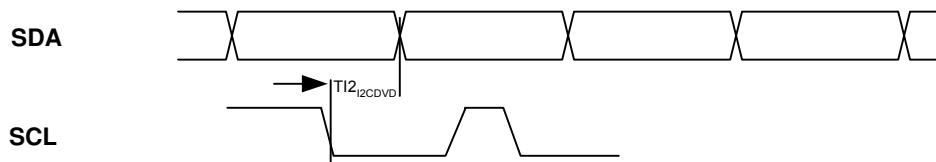


Figure 9. I²C Data Valid Delay (driving Read Cycle data)

Pin Descriptions

Input Pins

Pin Name	Pin #	Type	Description
D[23:12]	36-47	In	Top half of 24-bit pixel bus. When BSEL = HIGH , this bus inputs the top half of the 24-bit pixel bus. When BSEL = LOW , these bits are not used to input pixel data. In this mode, the state of D[23:16] is input to the I ² C register CFG. This allows 8-bits of user configuration data to be read by the graphics controller through the I ² C interface (see I ² C register definition). When not used D[23:16] should be tied to ground. D[15:12] are reserved for SiI use only and should be tied to GND.
D[11:0]	50-55, 58-63	In	Bottom half of 24-bit pixel bus / 12-bit pixel bus input. When BSEL = HIGH , this bus inputs the bottom half of the 24-bit pixel bus. When BSEL = LOW , this bus inputs ½ a pixel (12-bits) at every latch edge (both falling and/or rising) of the clock.
IDCK+	57	In	Input Data Clock +. This clock is used for all input modes.
IDCK-	56	In	Input Data Clock -. This clock is only used in 12-bit mode when dual edge clocking is turned off (DSEL = LOW). It is used to provide the ODD latching edges for dual clock single edge. If BSEL = HIGH or DSEL = HIGH , this pin is unused and should be tied to GND.
DE	2	In	Input Data Enable. This signal qualifies the active data area. DE is always required by the transmitter and must be high during active display time and low during blanking time.
HSYNC	4	In	Horizontal Sync input control Signal
VSYNC	5	In	Vertical Sync input control signal.
CTL1/A1/DK1 CTL2/A2/DK2 CTL3/A3/DK3	8 7 6	In	The use of these multi-function inputs depends on the settings of ISEL/RST# and DKEN. These inputs are regular high-swing 3.3V CMOS level inputs. These pins contain weak pull-down resistors so that if left unconnected, they will be LOW. When ISEL/RST# = LOW, DKEN = LOW General Purpose Input CTL[3:1] pins are active, for backward compatibility. These pins must be used to send DC signals only during the blanking time. When ISEL/RST# = LOW, DKEN = HIGH DK[3:1] are active, these inputs are used to select the De-skewing setting for the input bus. When ISEL/RST# = HIGH, DKEN = HIGH A[3:1] are active, these bits are used to set the lower 3 bits of the I ² C device address.

Pin Descriptions (cont'd)

Configuration Pins

Pin Name	Pin #	Type	Description
MSEN	11	Out	Monitor Sense. This pin is an open collector output. The behavior of this output depends on whether I ² C interface active: I²C bus inactive (ISEL/RST# = LOW) HIGH level indicates a powered on receiver is detected at the differential outputs. A LOW level indicates a powered on receiver is not detected. I²C bus is enabled (ISEL/RST# = HIGH) The output is programmable through the I ² C interface (see I ² C Register Definitions). An external 5K pull-up resistor to VDDQ is required on this pin.
ISEL/RST#	13	In	I ² C Interface Select. ISEL/RST#=HIGH, I ² C interface is active. ISEL/RST#=LOW, I ² C is inactive and the chip configuration is read from the configuration strapping pins. This pin also acts as an asynchronous reset to the I ² C interface controller. The reset is active when this input is held LOW. Note: When the I ² C interface is active, DKEN must be set HIGH.
BSEL/SCL	15	In	Input bus select / I ² C clock. This pin is an open collector input. If I ² C bus is enabled (ISEL/RST# = HIGH), then this pin is the I ² C clock input. If the I ² C is disabled (ISEL/RST# = LOW), then this pin selects the input bus width. Input Bus Select: HIGH selects 24-bit input mode LOW selects 12-bit input mode
DSEL/SDA	14	In/Out	Dual edge clock select / I ² C Data. This pin is an open collector input/output. If I ² C bus is enabled (ISEL/RST# = HIGH), then this pin is the I ² C data line. If the I ² C bus is disabled (ISEL/RST# = LOW), then this pin selects whether single clock dual edge is used. Dual Edge clock select: When HIGH, IDCK+ latches input data on both falling <u>and</u> rising clock edges. When LOW, IDCK+/IDCK- latches input data on only falling or rising clock edges. In 24-/12-bit mode: If HIGH (dual edge), IDCK+ is used to latch data on both falling and rising edges. If LOW (single edge), IDCK+ latches 1 st half data and IDCK- latches 2 nd half data.
EDGE/ HTPLG	9	In	Edge select / Hot Plug input. If the I ² C bus is enabled (ISEL/RST# = HIGH), then this pin is used to monitor the "Hot Plug" detect signal (Please refer to the DVI TM or VESA [®] P&D TM and DFP standards). This Input is ONLY 3.3V tolerant and has no internal de-bouncer circuit. If I ² C bus is disabled (ISEL/RST# = LOW), then this pin selects the clock edge that will latch the data. How the EDGE setting works depends on whether dual or single edge latching is selected: Dual Edge Mode (DSEL = HIGH) EDGE = LOW, the primary edge (first latch edge after DE is asserted) is the falling edge. EDGE = HIGH, the primary edge (first latch edge after DE is asserted) is the rising edge. Note: In 24-bit Single Clock Dual Edge mode, EDGE is ignored. Single Edge Mode (DSEL = LOW) EDGE = LOW, the falling edge of the clock is used to latch data. EDGE = HIGH, the rising edge of the clock is used to latch data.
DKEN	35	In	De-skewing enable. I²C mode (ISEL/RST# = HIGH) DKEN pin must be set to HIGH. DK[3:1] pins are ignored and the De-skewing increments are selected through the I ² C interface (see the I ² C register definitions). Non I²C mode (ISEL/RST# = LOW) DKEN = LOW, then default De-skewing setting is used. DKEN = HIGH, then DK[3:1] is used as the De-skewing setting. The De-skewing increments are T _{STEP} . Please see Data De-skew Feature for an illustration.

Pin Descriptions (cont'd)

Input Voltage Reference Pin

Pin Name	Pin #	Type	Description
VREF	3	Analog In	<p>Input Reference Voltage. Selects the Swing range of the digital inputs, which include only D[23:0], IDCK+, IDCK-, DE, VSYNC, and HSYNC. Input pins SCL and SDA, RST, BSEL, DSEL, EDGE and PD# require 3.3V high swing signals and are not changed by the VREF input.</p> <p>To set the digital inputs to 3.3V High Voltage Swing, VREF must be set to 3.3V.</p> <p>To set the digital inputs to Low Voltage Swing, VREF must be set to ½ of VDDQ where VDDQ is swing level of input signal. Thus for DVO mode (1.5V Low Voltage Swing) VREF should be set to 0.75V and BSEL=LOW.</p>

Power Management Pins

Pin Name	Pin #	Type	Description
PD#	10	In	<p>Power Down (active LOW). A HIGH level indicates normal operation. A LOW level indicates Power Down mode. In Power Down mode the Analog core is disabled and Output buffers/pins are tri-stated however the Input buffer/pins and I²C Block for read and write are active. PD# pin is disabled during I²C mode. PD# should be tied low during I²C mode.</p>

Differential Signal Data Pins

Pin Name	Pin #	Type	Description
TX0+	25	Analog	<p>TMDS Low Voltage Differential Signal input data pairs.</p> <p>These pins are tri-stated when PD# is pulled low.</p>
TX0-	24	Analog	
TX1+	28	Analog	
TX1-	27	Analog	
TX2+	31	Analog	
TX2-	30	Analog	
TXC+	22	Analog	<p>TMDS Low Voltage Differential Signal input clock pair.</p> <p>These pins are tri-stated when PD# is pulled low.</p>
TXC-	21	Analog	
EXT_SWING	19	Analog	<p>Voltage Swing Adjust. A resistor should tie this pin to AVCC. This resistor sets the amplitude of the voltage swing. A smaller resistor value sets a larger voltage swing and vice versa. For remote display applications a 510Ω with ± 5% (max) tolerance resistor is recommended. While for notebook computers 680Ω is recommended to ensure voltage swing is not overdriven over a short cable distance.</p>

Reserved Pins

Pin Name	Pin #	Type	Description
RESERVED	34	In	Must be tied LOW for normal operation.

Power and Ground Pins

Pin Name	Pin #	Type	Description
VCC	1,12,33	Power	Digital VCC, must be set to 3.3V nominal.
GND	16,48,64	Ground	Digital GND.
AVCC	23,29	Power	Analog VCC, must be set to 3.3V nominal.
AGND	20,26,32	Ground	Analog GND.
PVCC1	18	Power	Primary PLL Analog VCC, must be set to 3.3V nominal.
PVCC2	49	Power	Filter PLL Analog VCC, must be set to 3.3V nominal.
PGND	17	Ground	PLL Analog GND.

I²C Registers

I²C Register Mapping

Addr	Reset Value	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x00	0x01	VND_IDL							
0x01	0x00	VND_IDH							
0x02	0x06	DEV_IDL							
0x03	0x00	DEV_IDH							
0x04	0x00	DEV_REV							
0x05	0x00	RSVD							
0x06	0x19	FRQ_LOW							
0x07	0x64	FRQ_HIGH							
0x08	00●●●● ●0	RSVD		<i>VEN</i>	<i>HEN</i>	<i>DSEL</i>	<i>BSEL</i>	<i>EDGE</i>	PD#
0x09	●000 0●●0	<i>RSVD</i>	MSEL			<i>TSEL</i>	<i>RSEN</i>	<i>HTPLG</i>	MDI
0x0A	0x90	<i>DK[3:1]</i>			<i>DKEN</i>	<i>CTL[3:1]</i>			RSVD
0x0B	●●●● ●●●●	CFG[7:0]							
0x0C	●●●0 ●●●●	<i>SCNT</i>	RSVD		<i>PLL[3:0]</i>				<i>PFEN</i>
0x0D	0x80	RSVD							
0x0E	0x00	RSVD							
0x0F	0x00	RSVD							

Notes

- All values are Bit 7 [MSB] and Bit 0 [LSB].
- Bits and registers **bold like this** are read only. All others are Read/Write.
- Bits and registers ***in italics and bold like this*** are undefined after RESET, although they are accessible by read or write.
- RSVD is a reserved register or bit field. It is available for future use by Silicon Image. All RSVD fields are read-only and are not affected by data written to them.
- 0x0C is also called the **VDJK** Register. Default setting for the VDJK register 0x0C is 0x89, which is optimum for most applications.

I²C Reset values are shown in the column at the left of the table. Bits or registers which have no default value after power-on, or which have no defined value after RESET, are shown with the symbol ● in the table. All registers Hexadecimal values use a prefix of '0x'. Binary values use a prefix of '0b'. To enable the device, registers 0x08, 0x09, 0x0A and 0x0C must be programmed. A sample programming sequence is listed on page 18 for 12-bit mode.

I²C Register Definitions

Register Name	Access	Description
VND_IDL	RO	Vendor ID Low byte (01h)
VND_IDH	RO	Vendor ID High byte (00h)
DEV_IDL	RO	Device ID Low byte (06h)
DEV_IDH	RO	Device ID High byte (00h)
DEV_REV	RO	Device Revision (00h)
FRQ_LOW	RO	Low frequency limit at 1-pixel/clock mode (MHz) (19h)
FRQ_HIGH	RO	High frequency limit at 1-pixel/clock mode Max frequency minus 65MHz (MHz) (64h)
PD	RW	Power Down mode (same function as PD# pin) 0 – Power Down (Default after RESET) 1 – Normal operation
EDGE	RW	Edge Select (same function as EDGE pin) 0 – Input data is falling edge latched (falling edge latched first in dual edge mode) 1 – Input data is rising edge latched (rising edge latched first in dual edge mode)
BSEL	RW	Input Bus Select (same function as BSEL pin) 0 – Input data bus is 12-bits wide 1 – Input data bus is 24-bits wide
DSEL	RW	Dual Edge Clock Select (same function as DSEL pin) 0 – Input data is single edge latched 1 – Input data is dual edge latched
HEN	RW	Horizontal Sync Enable: 0 – HSYNC input is transmitted as fixed LOW 1 – HSYNC input is transmitted as is
VEN	RW	Vertical Sync Enable: 0 – VSYNC input is transmitted as fixed LOW 1 – VSYNC input is transmitted as is
MDI	RW	Monitor Detect Interrupt 0 – Detection signal has changed logic level (write one to this bit to clear) 1 – Detection signal has not changed state
HTPLG	RO	Hot Plug Detect input, the state of HTPLG pin can be read from this bit
RSEN	RO	Receiver Sense (only available for use in DC coupled systems) 0 – Active/Powered Receiver not detected 1 – Active/Powered Receiver detected
TSEL	RW	Interrupt Generation Method 0 – Interrupt bit (MDI) is generated by monitoring RSEN 1 – Interrupt bit (MDI) is generated by monitoring HTPLG
MSEL[2:0]	RW	Select source of the MSEN output pin 000 – Force MSEN outputs high (disabled – default after RESET) 001 – Outputs the MDI bit (interrupt) 010 – Output the RSEN bit (receiver sense detect) 011 – Outputs the HTPLG bit (hotplug detect) 1xx – RESERVED
VLOW	RO	VREF setting 1 – Indicates High Swing Input Mode 0 – Indicates Low Swing Input Mode
CTL[3:1]	RW	General purpose inputs (same as CTL[3:1] pins). These bits are only transmitted during blanking period.

I²C Register Definitions (cont'd)

Register Name	Access	Description
CFG[7:0]	RO	Contains state of inputs D[23:16]. These pins can be used to provide user selectable configuration data through the I ² C bus. Only available in 12-bit mode
PFEN	RW	PLL Filter Enable in the VDJK Register 0x0C. 1 – To enable PLL Filter (recommended setting) 0 – To disable PLL Filter
PLLF[3:1]	RW	Set characteristics of PLL filter in VDJK Register 0x0C. 100 – Recommended value All other values are not recommended.
SCNT	RW	SYNC Continuous 1 – To enable (recommended setting) 0 – To disable
DK[3:1]	RW	De-skewing Setting. Increment 260psec. 000 – 1 step -> minimum setup / maximum hold 001 – 2 step 010 – 3 step 011 – 4 step 100 – 5 step -> default (recommended setting) 101 – 6 step 110 – 7 step 111 – 8 step -> maximum setup / minimum hold Please see Data De-Skew Feature for an illustration
DKEN	RW	De-skewing Enable through DK[3:1] bits. When DKEN pin is HIGH via pin or set to 1, then De-skew is enabled. When set to 0 De-skew is disabled. Please see Data De-skew Feature on page 16 for an illustration.

I²C Slave Interface and Address

The Si1 164 slave state machine does not require an internal clock and support only byte read and write. Page mode is not supported. The 7-bit binary address of the I²C machine is “0111 A₃A₂A₁R” where R =1 sets a read operation while R=0 sets a write operation. Please see Figure 10 for a Byte Read operation and Figure 11 for a byte write operation. For more detailed information on I²C protocols please refer to I²C Bus Specification version 2.1 available from Philips Semiconductors Inc.

When ISEL/RST# = HIGH and DKEN = HIGH, pins 6,7,8 functions as A[3:1]. Each pin can be set to HIGH or LOW to select a desired I²C address for the Si1 164. To set the Si1 164 to 0x72, tie pin 7 and 6 to ground and pull pin 8 to VCC via 2.2K resistor. The recommended setting is to tie pins 6,7 and 8 to ground to set “000” or address 0x70 in I²C mode .

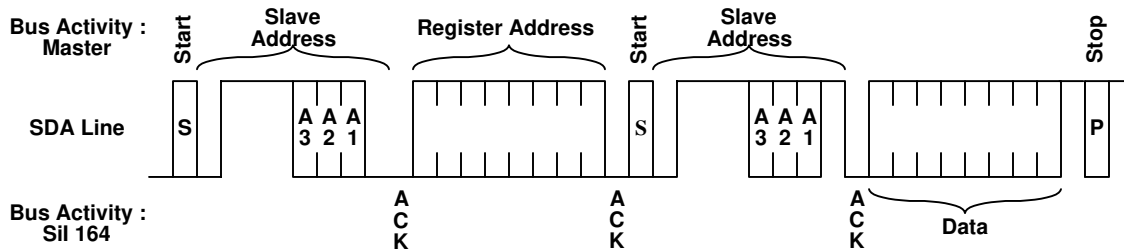


Figure 10. I²C Byte Read

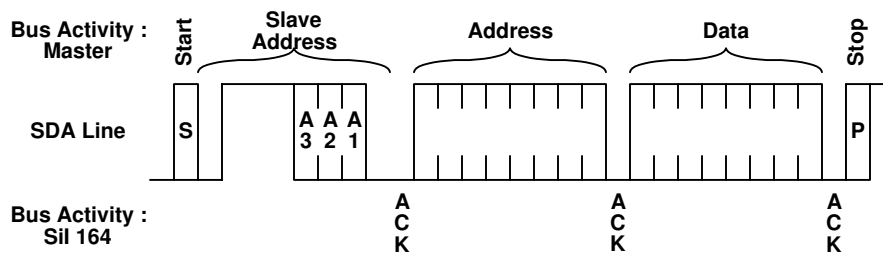


Figure 11. I²C Byte Write

Data De-skew Feature

The de-skew feature allows adjustment of the clock-to-data delay on the input of the SiI 164. When driven by a chip with clock and data timings which do not meet the setup and hold time requirements of an SiI 164, the de-skew register value can be modified to position the clock in the middle of the valid data time and meet the input setup and hold times. As shown in Figure 12, changing the DK[3:1] value from 0b100 to 0b111 delays the internal clock by approximately 750ps to 900ps, increasing setup time and reducing hold time. This is useful when the input clock, IDCK, arrives too early.

The default values for DK[3:1] are shown in Table 1, along with approximate times per setting. Note that the default is different when enabling I²C mode (ISEL/RST#=HIGH) versus non-I²C mode (ISEL/RST#=LOW). Positive values of T_{CD} move the clock later, increasing setup time. Negative values of T_{CD} move the clock earlier, increasing hold time.

Where:

T_{CD} is the amount of setup/hold timing variation

DK[3:1] is the setting of the de-skew configuration pins or I²C registers

Table 1. Data De-Skew Estimated Values

DK[3:1]	De-Skew Time T_{CD}
0b111	+0.75ns to +0.90ns
0b110	+0.50ns to +0.70ns
0b101	+0.20ns to +0.35ns
0b100	0
0b011	-0.20ns to -0.35ns
0b010	-0.50ns to -0.70ns
0b001	-0.75ns to -0.90ns
0b000	-1.0ns to -1.2ns

Default De-Skew

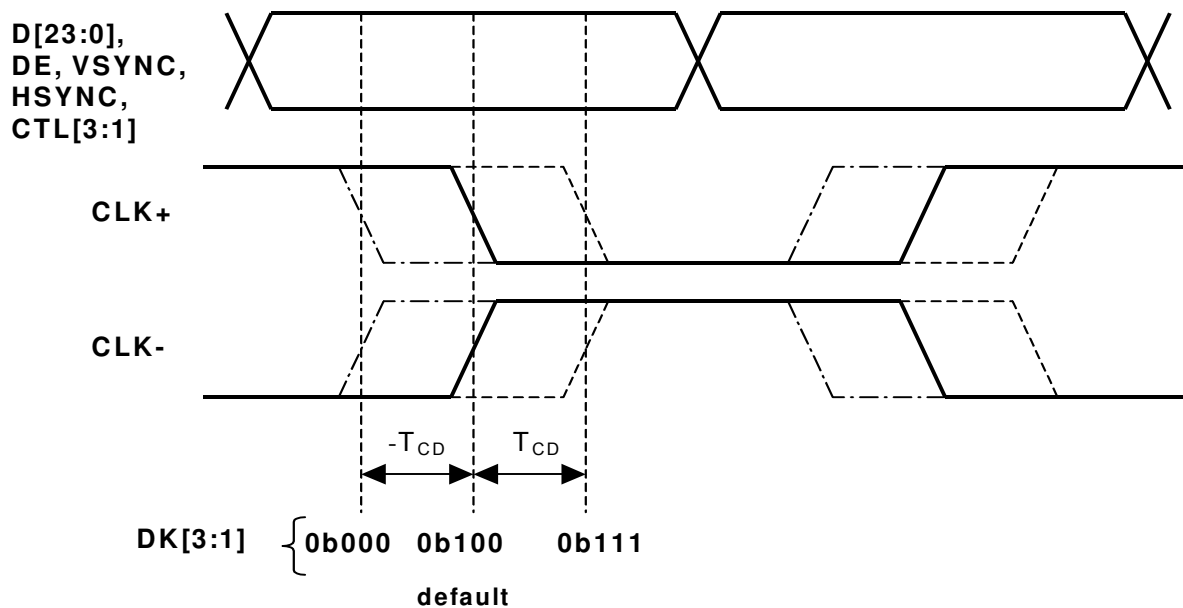


Figure 12. SiI 164 Data De-skew Feature Timing

Data Latching Modes

SI 164 can be set to different to operate in either 12-bit or 24-bit input mode. In either mode the SI 164 can be set to latch data at either rising or falling edge of the clock or support dual edge clocking mode. Figure 13 illustrates the latching edge for a 12-bit data input (**BSEL = 0**) by changing DSEL and EDGE option. Clock edges represented by arrows signify the latching edge. For Dual Edge mode, the dark arrows indicate the primary latch edge.

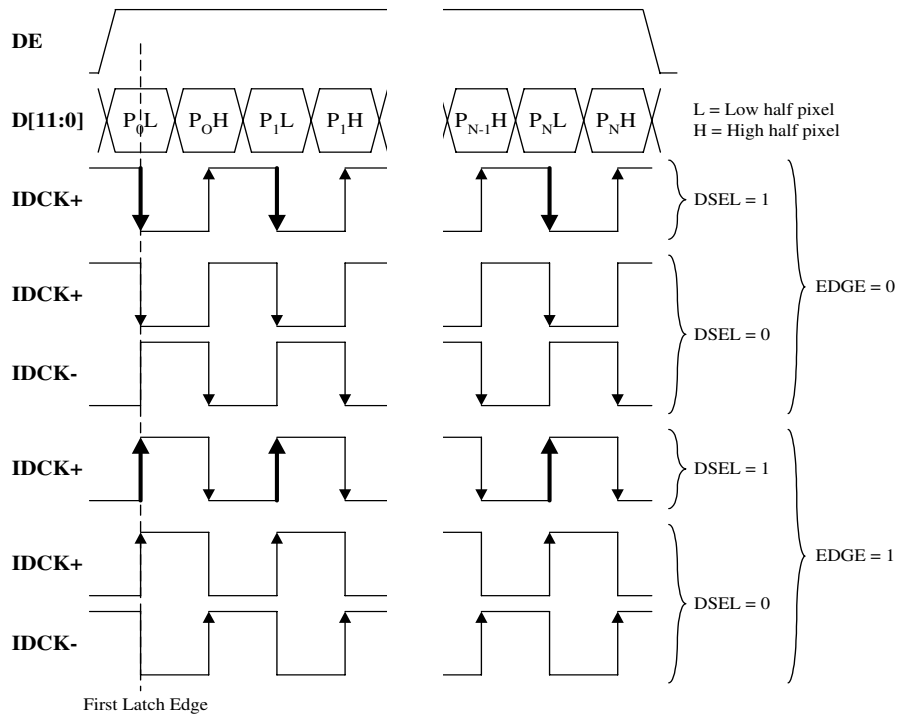


Figure 13. 12-bit Input Data Latching

Figure 14 illustrates the latching edge for a 24-bit data input (**BSEL=1**) with DSEL and EDGE option. EDGE pin has no affect in 24-bit Single Clock Dual Edge Mode.

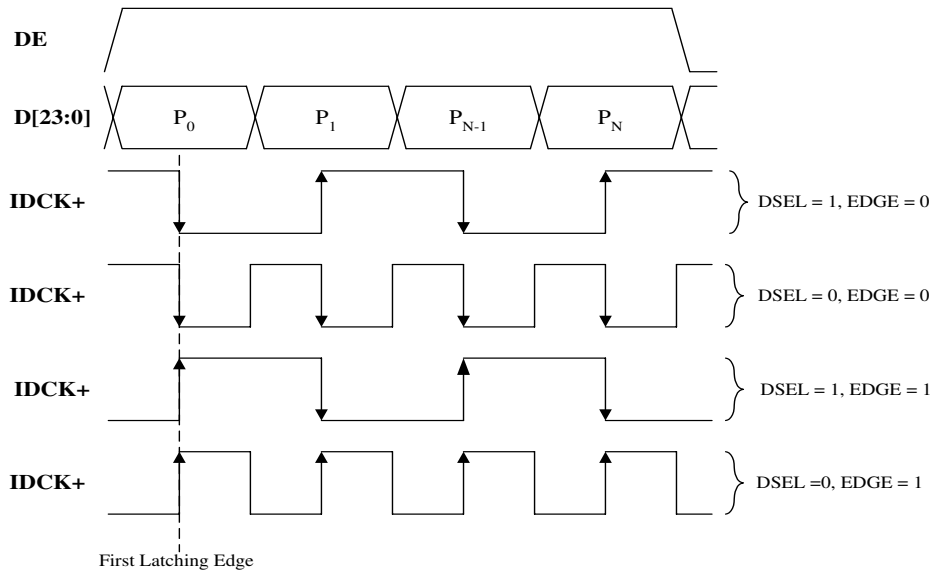


Figure 14. 24-bit Input Data Latching

I²C Programming Sequence

To program the SiI 164 in data latched on 12-bit mode Dual Edge Clock with Primary Edge as the rising edge or falling edge, De-skew enabled with Hotplug based monitor detection use the following sample programming sequence listed in Table 2. It is important to note that the suggested I²C address for SiI 164 be set to 0x70 by tying pins A1, A2 and A3 to ground.

Table 2. Sample Programming Sequence for SiI 164 in 12-bit Mode

Register(Hex)	Value(Hex)	Description
0x08	Setting 1: 0x30 Setting 2: 0x32	Setting 1: Enable HEN, VEN, 1 st data latched on falling edge with PD low until all registers are programmed. Setting 2: Enable HEN, VEN, 1 st data latched on rising edge with PD low until all registers are programmed.
0x09	0x30	Monitor detection mode via Hotplug input.
0x0A	0x90	De-skew enabled with default 100 value. CTL is not used.
0x0C	0x89	SCNT, PLL Filter Enable and PLL Bandwidth Filter set to default.
0x08	Setting 1: 0x31 Setting 2: 0x33	Setting 1: Recover from Power Down mode and enable output. Setting 2: Recover from Power Down mode and enable output.

Enabling Hot Plug Detection Mode

As documented in the VESA Digital Flat Panel Standard, all monitors are required to support Hot Plug Detection but support is optional for the host. The SiI 164 supports the Hot Plug Detect feature. In I²C mode, pin 9 functions as HTPLG input. It should be noted that the HTPLG pin on the SiI 164 is only 3.3V tolerant therefore HTPLG voltage level from the DVI connector should be level shifted or clamped at 3.3V.

When the voltage level at the HTPLG pin is 3.3V, the HTPLG bit will be set to 1. To output the HTPLG bit via the MSEN pin, register MSEL[2:0] should be programmed to 0b011.

The SiI 164 can also be programmed to enable the Hot Plug Detection Mode via the Receiver Sense function. In this mode, HTPLG pin is not required. By programming MSEL[2:0] to 0b010, SiI 164 will output the RSEN=1 bit through the MSEN pin when the SiI 164 is connected to a powered receiver.

Non-I²C/Strap Mode Configuration

The SiI 164 can be set to program itself at power up without writing any SiI 164 registers via I²C. The SiI 164 is extremely flexible and can be set to operate in any input format that can be set in I²C mode. In non I²C mode, specific configuration pins need to be strapped to either high or low to set the desired mode. Figure 15 provides a schematic example of all the pins that can be configured to enable the various modes in non I²C mode. Table 3 lists resistors to be stuffed for a specific mode.

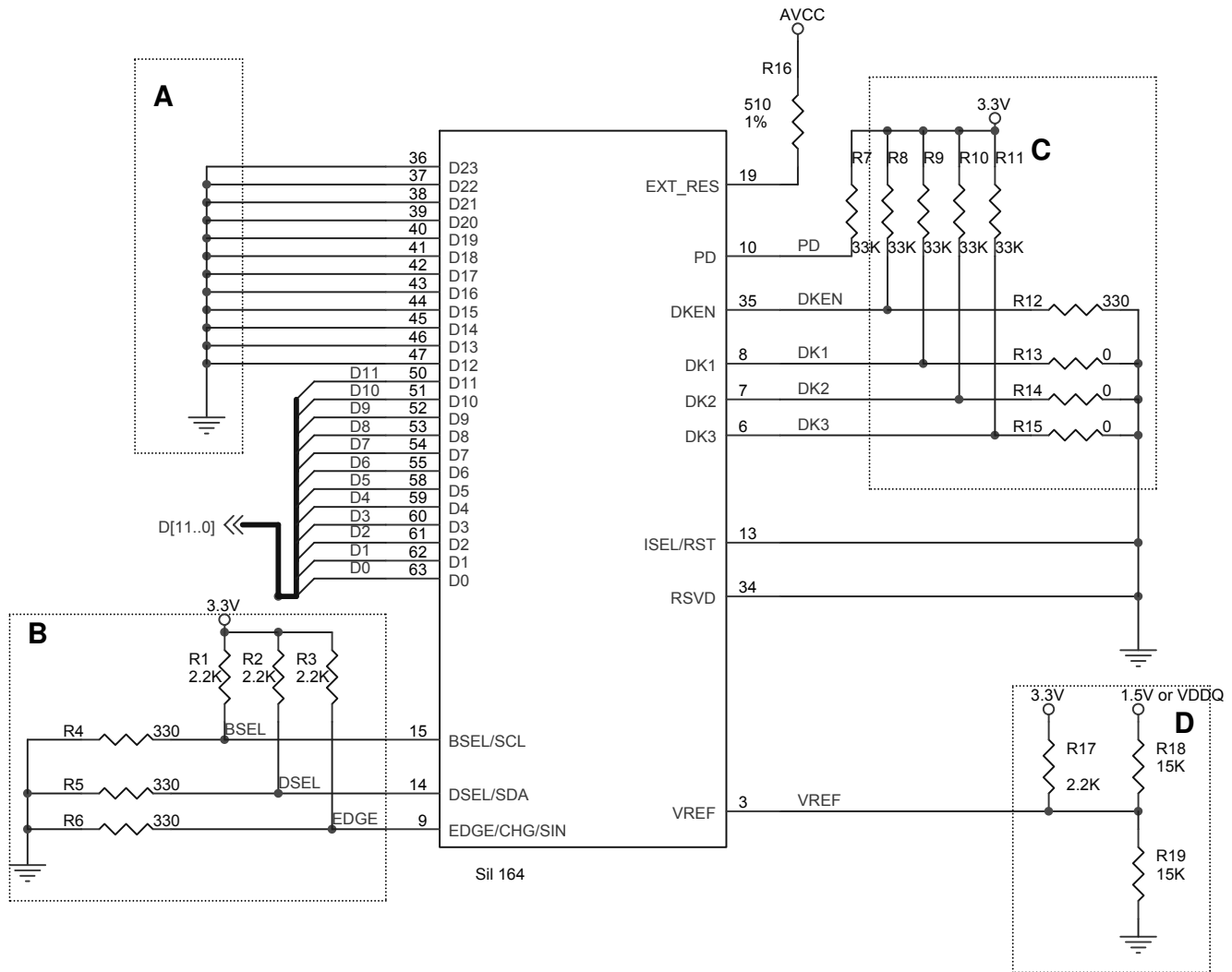


Figure 15. Non-I²C/Strap Mode Schematic Example

Non-I²C/Strap Mode Configuration (cont'd)

ISEL/RST# and RSVD pins must always be tied to ground for strap or non- I²C mode. PD# must be tied high or the SiI 164 will still be in Power Down mode when VCC is applied.

In Figure 15 **Block A** corresponds to the upper 12-bits (D [23:12]) of the SiI 164. When not in use, they should always be tied to ground. **Block B** controls the Input Bus data width, Dual Edge Clock Select and Edge Select. IDCK- is only used in 12-bit mode. In 24-bit mode or Dual Edge Clock select IDCK- should be tied to ground. **Block C** controls the De-skewing options. **Block D** determines the input voltage level swing. A full description of each pin can be found in the Pin Description section of this document.

Table 3. Non-I²C/Strap Mode Options

MODE	BLOCK A	BLOCK B	BLOCK C	BLOCK D
1. 24-bit ¹ 2. Single Clock 3. Dual Edge 4. Falling Edge latching 1 st pixel 5. De-skewing enabled to 100 6. High Voltage Swing	Connect D[23:12] to Graphics Host	Stuff only R1, R2, R6	Stuff only R8, R13, R14, R11	Stuff Only R17
1. 24-bit 2. Single Clock 3. Single Edge 4. Falling Edge 5. De-skewing disabled 6. High Voltage Swing.	Connect D[23:12] to Graphics Host	Stuff only R1, R5, R6	Stuff only R12, R13, R14, R15	Stuff Only R17
1. 12-bit ² 2. Single Clock 3. Dual Edge 4. Rising Edge of IDCK+ latching 1 st ½ pixel 5. De-skewing disabled 6. High Voltage Swing.	Ground D[23:12]	Stuff only R4, R2, R3	Stuff only R12, R13, R14, R15	Stuff Only R17
1. 12-bit ³ 2. Dual Clock 3. Dual Edge, 4. Falling Edge of IDCK+ latching 1 st ½ pixel 5. De-skewing enabled to 100 6. Low Swing Mode	Ground D[23:12]	Stuff only R4, R5, R6	Stuff only R8, R13, R14, R11	Stuff Only R18, R19

Notes

- In 24-bit IDCK+ is input clock. IDCK- should be tied to ground.
- In 12-bit dual edge (non-DVO) mode, IDCK- is not used.
- This setting is equivalent to DVO mode. In DVO mode both IDCK+ and IDCK- must be connected.

TFT Panel Data Mapping

The following TFT data mapping tables are strictly listed for single link TFT applications only. SI 143B, SI 151B, SI 153B and SI 161B all have the same pinout. As such mapping will be the same when SI 143B or SI 151B or SI 153B is used in place of SI 161B.

Table 4. One Pixel/Clock Input/Output TFT Mode - VESA P&D and FPD1-2 Compliant

TFT VGA Output		Tx Input Data		Rx Output Data		TFT Panel Input	
24-bpp	18-bpp	160	164	161B	141B	24-bpp	18-bpp
B0		DIE0	D0	QE0	Q0	B0	
B1		DIE1	D1	QE1	Q1	B1	
B2	B0	DIE2	D2	QE2	Q2	B2	B0
B3	B1	DIE3	D3	QE3	Q3	B3	B1
B4	B2	DIE4	D4	QE4	Q4	B4	B2
B5	B3	DIE5	D5	QE5	Q5	B5	B3
B6	B4	DIE6	D6	QE6	Q6	B6	B4
B7	B5	DIE7	D7	QE7	Q7	B7	B5
G0		DIE8	D8	QE8	Q8	G0	
G1		DIE9	D9	QE9	Q9	G1	
G2	G0	DIE10	D10	QE10	Q10	G2	G0
G3	G1	DIE11	D11	QE11	Q11	G3	G1
G4	G2	DIE12	D12	QE12	Q12	G4	G2
G5	G3	DIE13	D13	QE13	Q13	G5	G3
G6	G4	DIE14	D14	QE14	Q14	G6	G4
G7	G5	DIE15	D15	QE15	Q15	G7	G5
R0		DIE16	D16	QE16	Q16	R0	
R1		DIE17	D17	QE17	Q17	R1	
R2	R0	DIE18	D18	QE18	Q18	R2	R0
R3	R1	DIE19	D19	QE19	Q19	R3	R1
R4	R2	DIE20	D20	QE20	Q20	R4	R2
R5	R3	DIE21	D21	QE21	Q21	R5	R3
R6	R4	DIE22	D22	QE22	Q22	R6	R4
R7	R5	DIE23	D23	QE23	Q23	R7	R5
Shift CLK	Shift CLK	IDCK	IDCK	ODCK	ODCK	Shift CLK	Shift CLK
VSYNC	VSYNC	VSYNC	VSYNC	VSYNC	VSYNC	VSYNC	VSYNC
HSYNC	HSYNC	HSYNC	HSYNC	HSYNC	HSYNC	HSYNC	HSYNC
DE	DE	DE	DE	DE	DE	DE	DE

For 18-bit mode, the Flat Panel Graphics Controller interfaces to the transmitter exactly the same as in the 24-bit mode; however, 6 bits per channel (color) are used instead of 8. It is recommended that unused data bits be tied low. As can be seen from the above table, the data mapping for less than 24-bit per pixel interfaces are MSB justified. The data is sent during active display time while the control signals are sent during blank time. Note that the three data channels (CH0, CH1, CH2) are mapped to Blue, Green and Red data respectively.